

CBM STS tracking system for BM@N

- I. Progress with CBM-STS*
- II. System definition of BM@N-STS*
- III. CBM-STS timeline, links to BM@N planning*

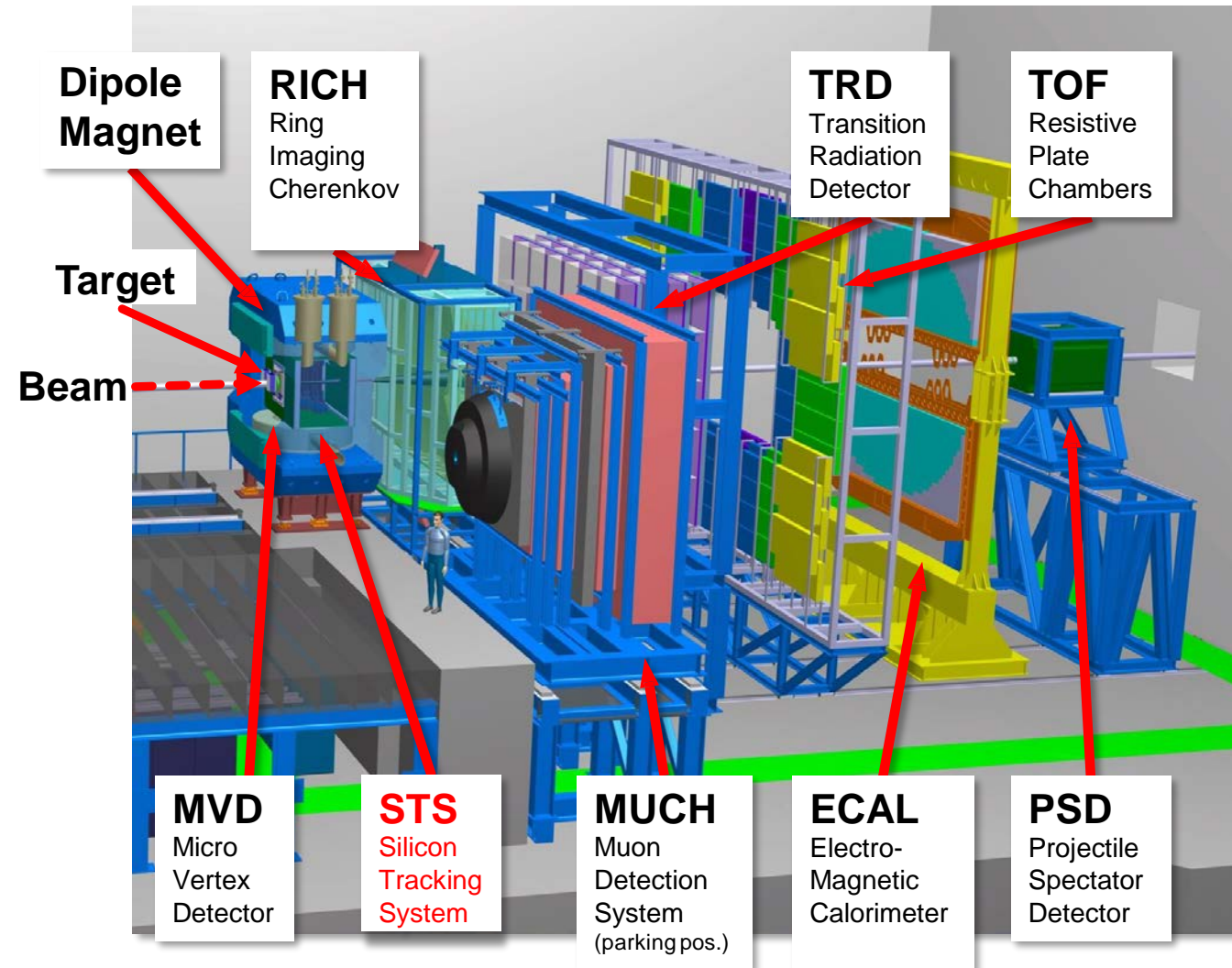
Johann M. Heuser, GSI Darmstadt
for the CBM-STS team

2nd Collaboration Meeting of the MPD and BM@N experiments at NICA
29 – 30 October 2018, JINR-VBLHEP, Dubna

I.

Progress with CBM-STS

STS in CBM Experiment at FAIR



- Tracking acceptance:
 $2^\circ < \theta_{\text{lab}} < 25^\circ$
- Free streaming DAQ
 $R_{\text{int}} = 10 \text{ MHz (Au+Au)}$
 with
 $R_{\text{int}} (\text{MVD}) = 0.1 \text{ MHz}$
- Software based event selection

Silicon Tracking System

Central CBM detector: charged-particle tracking + momentum measurement

Challenges:

- up to ~ 700 charged particles per heavy-ion collision → high granularity
- $10^5 - 10^7$ heavy-ion collisions per second → fast, radiation tolerant

Technical solutions:

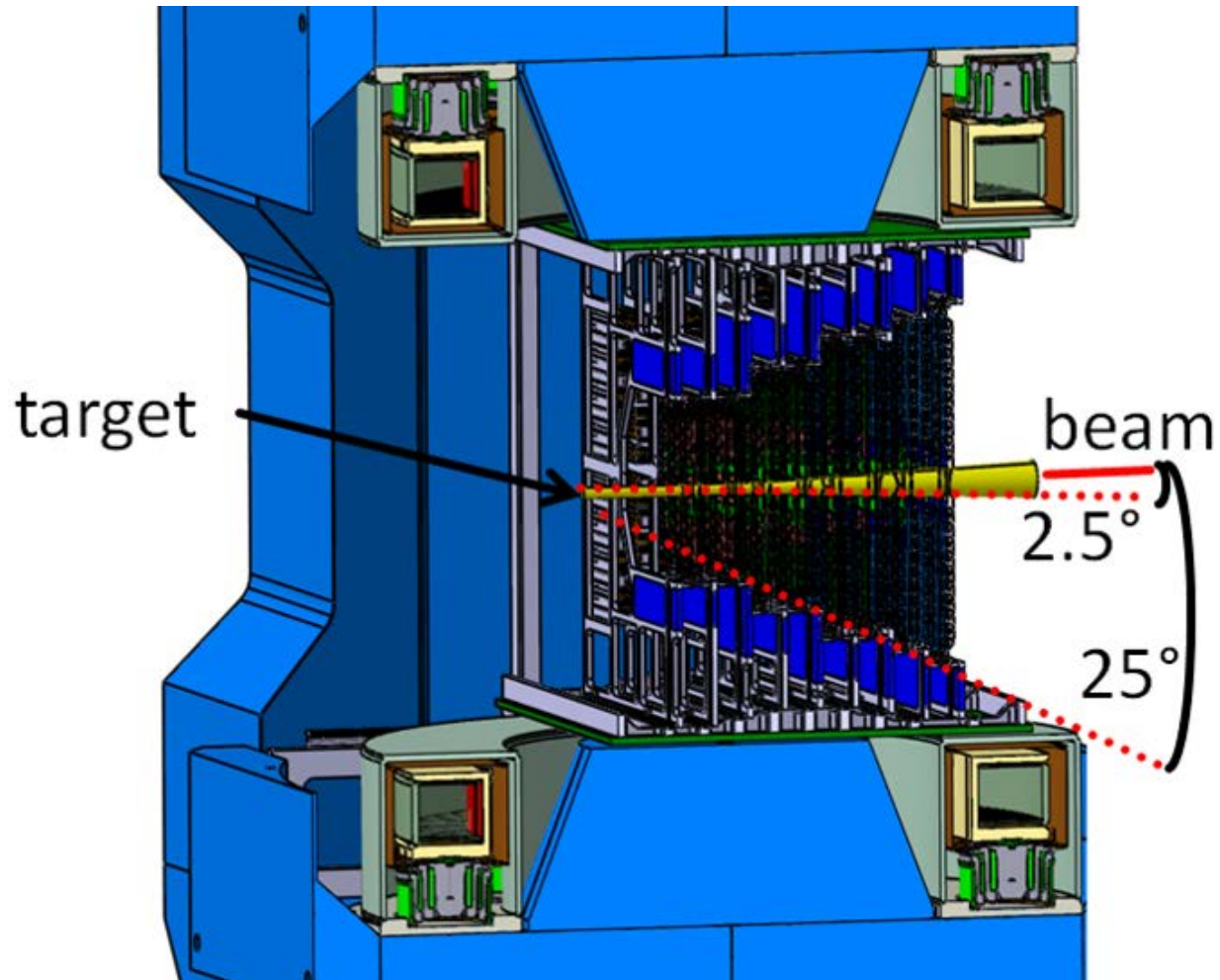
- **8 tracking stations, $\approx 4 \text{ m}^2$ total area, 896 detector modules, 106 ladders**
- *double-sided silicon microstrip sensors*
 - *hit spatial resolution $\approx 25 \mu\text{m}$*
 - *material budget per tracking station: $\approx 0.3\% - 2\% X_0$*
 - *radiation tolerance up to $1 \times 10^{14} \text{ n/cm}^2$ (1 MeV equivalent)*
- self-triggering electronics, time-stamp resolution $\approx 5 \text{ ns}$
- low-mass detector modules/ladders

Construction: 2019 – 2023

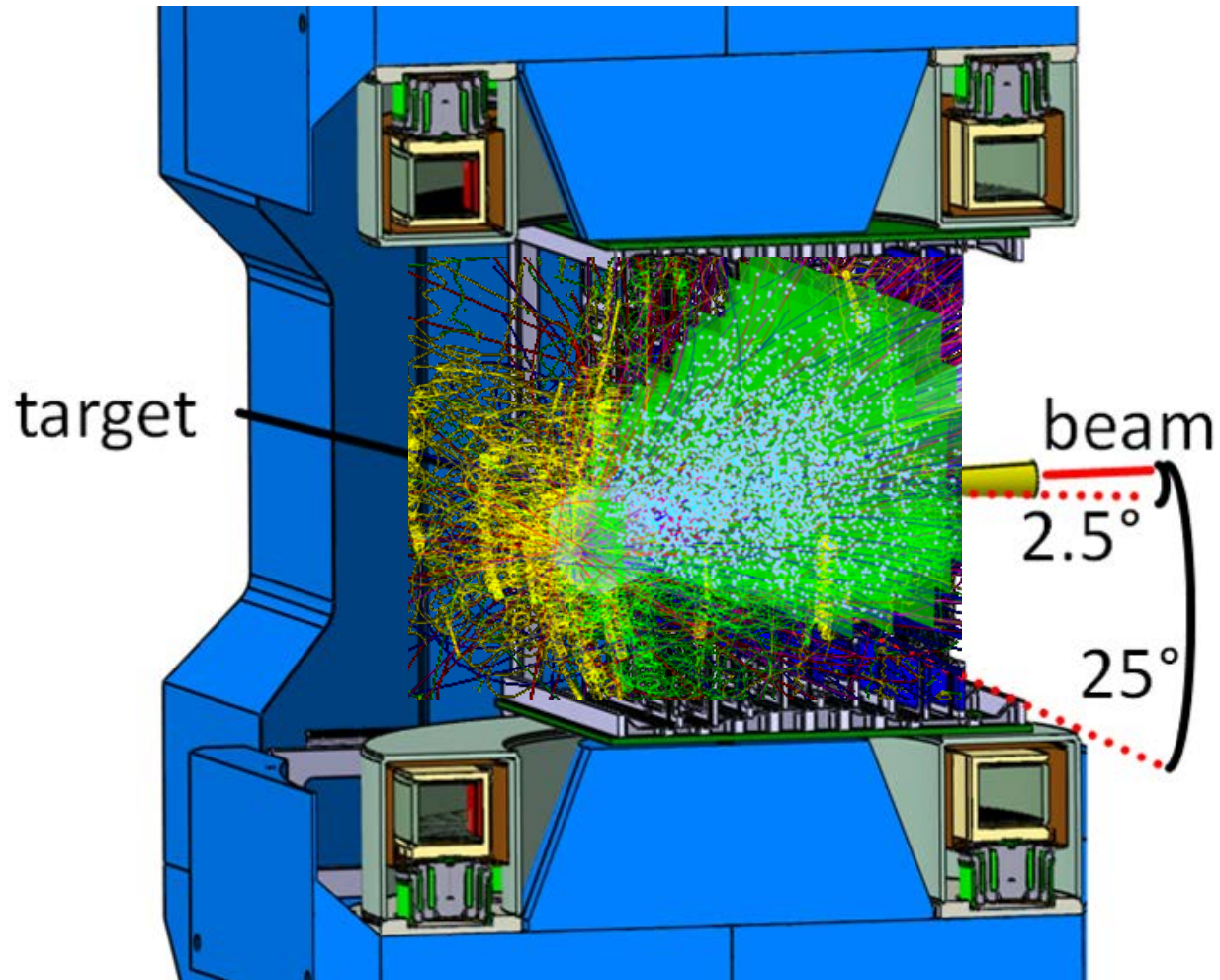
Install in CBM: 2024

Physics: 2025 ...

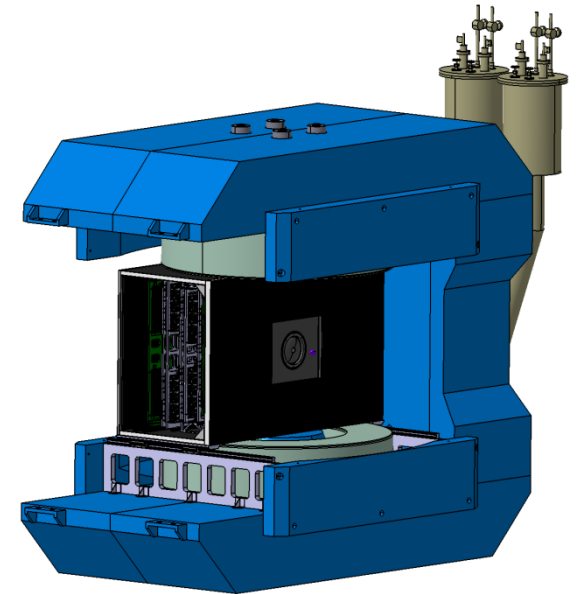
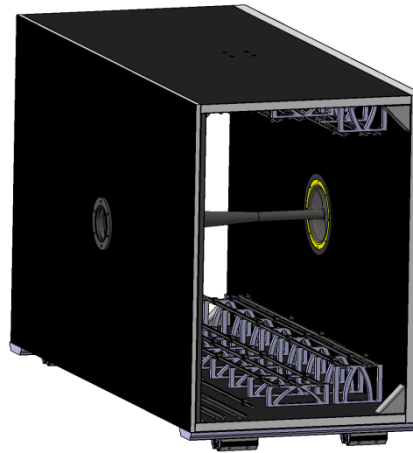
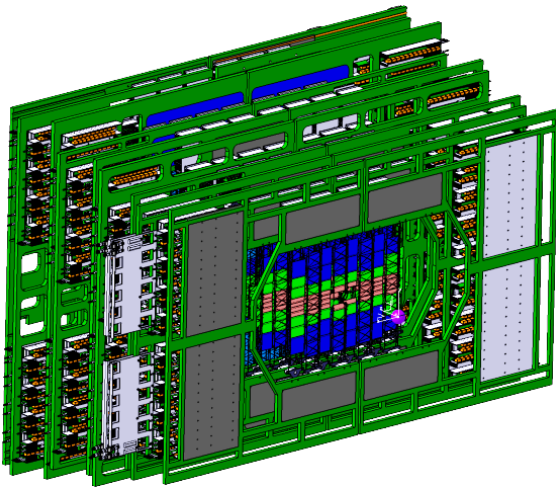
Silicon Tracking System



Silicon Tracking System



System Engineering



Consistent design being worked on. Current issues:

Mechanical frames:

- Sensor cooling
- Cooling plate shape / technology
- Cabling not tested
- Material
- Rail system
- Positioning / Adjustment

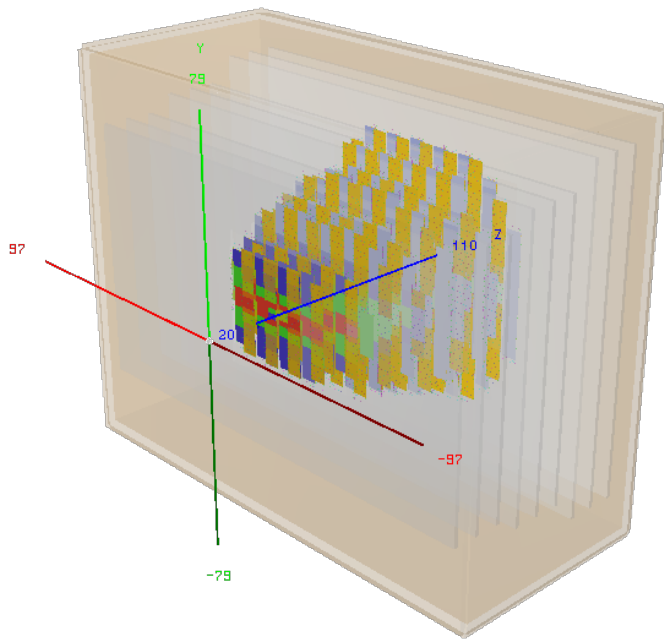
Thermal enclosure:

- Sealing
- Panel connections
- Material budget rear panel
- Overall stiffness
- C-Frame positioning / measurement / adjustment concept
- Service / support mechanics
- Overall assembly procedure is an idea

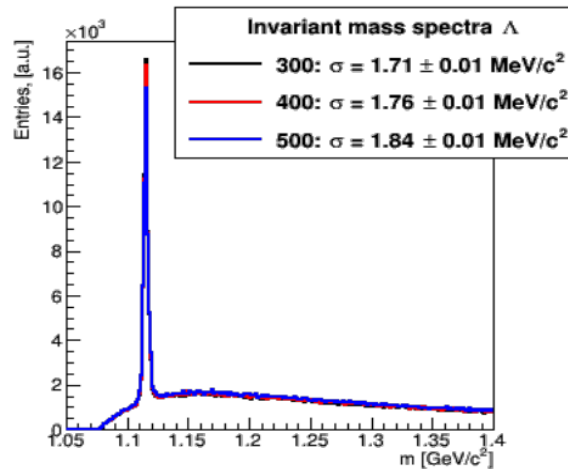
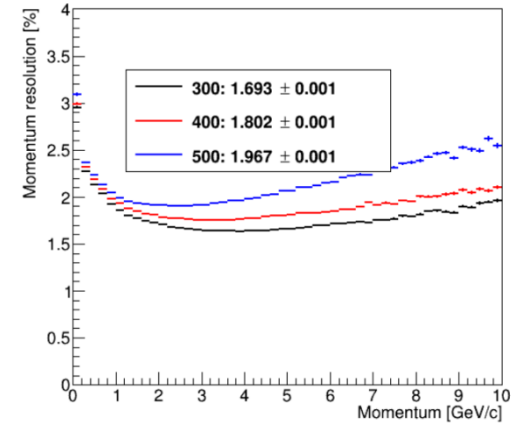
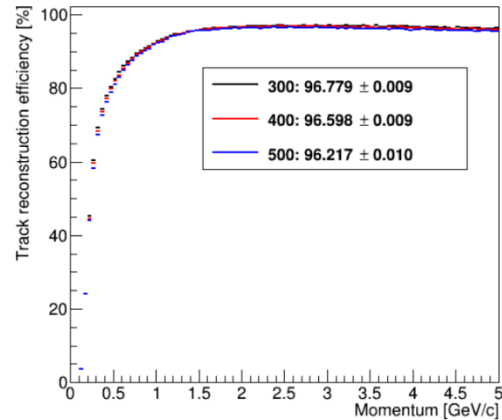
Global system aspects:

- STS services, mechanic supports and details
 - Cabling
 - Cooling
 - Positioning
 - Safety / emergency systems
 - Integration upstream and downstream
 - vibrations / structural analysis

Updated Performance Studies

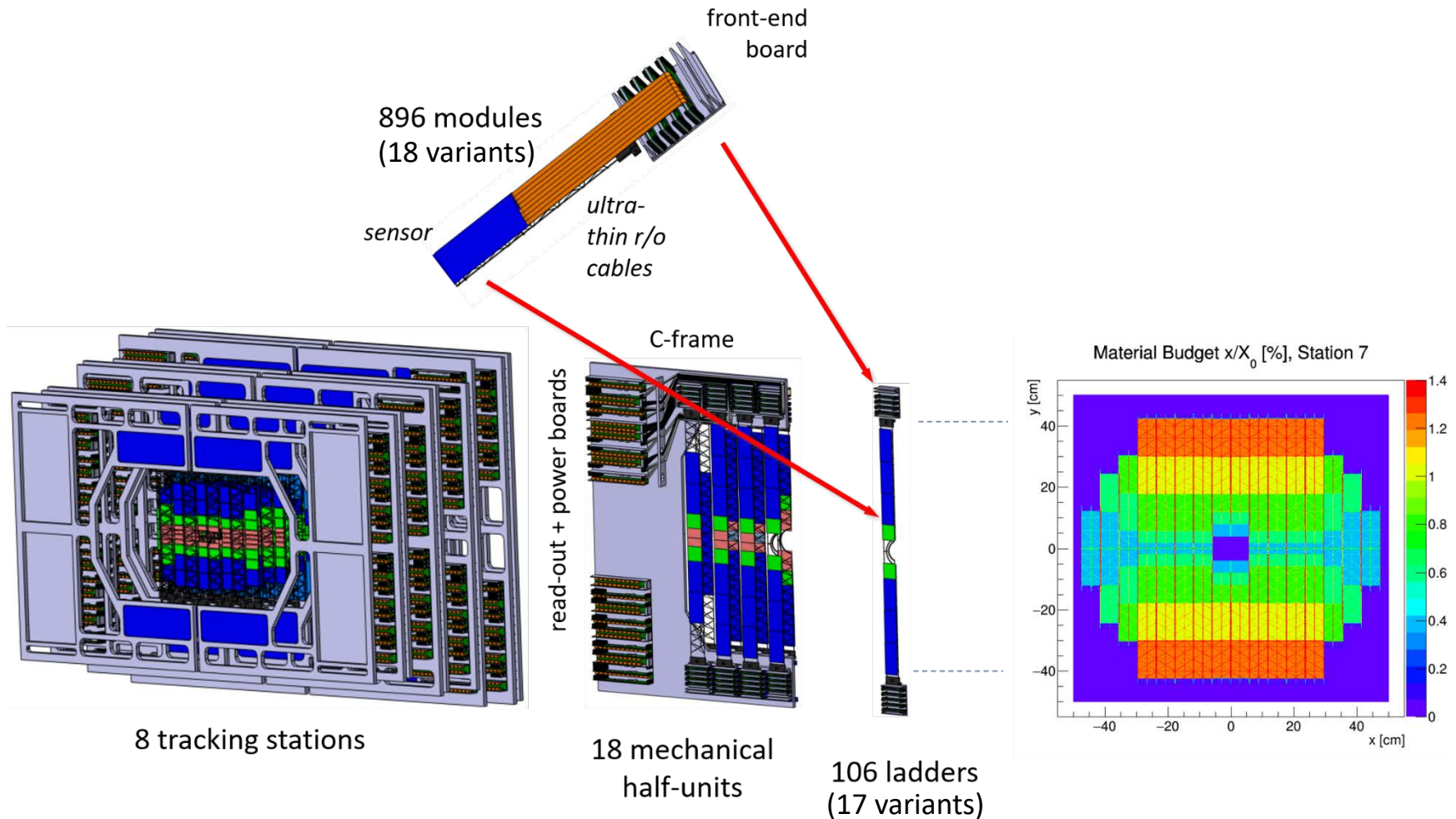


detector model with passive materials



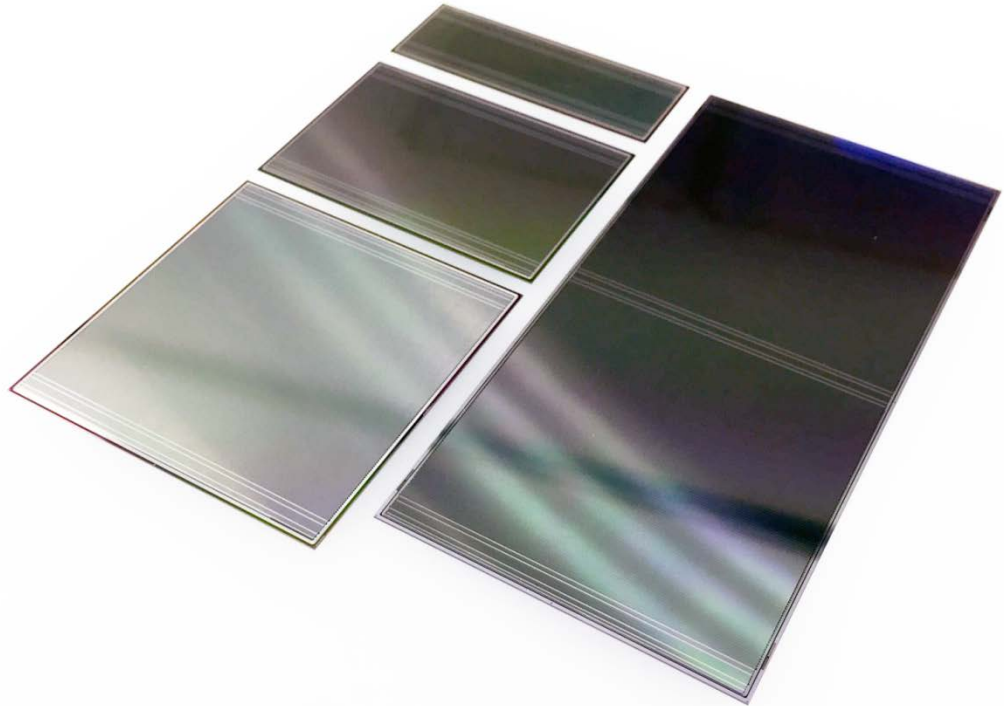
- track reco efficiency
- momentum resolution
- physics observables
- data rates
- delta electrons
- ...

STS – exploded view



Silicon Microstrip Sensors

- double-sided
- 1024 strips of 58 μm pitch
- 4 variants/strip lengths
- final prototypes realized with two vendors:
 - CiS, Germany
 - Hamamatsu, Japan



6.2 x 2.2 cm²

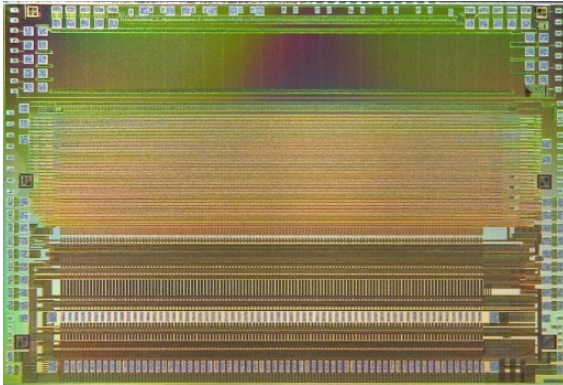
6.2 x 4.2 cm²

6.2 x 6.2 cm²

6.2 x 12.4 cm²

- Internal Sensor Review: April 2018
- Tendering: August – September 2018
Offers received, negotiations ahead
- Aim: Production 2019 – 2020

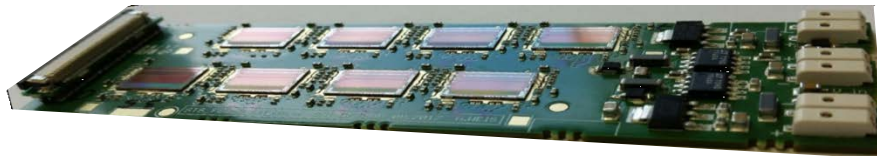
Front-end ASIC and read-out electronics



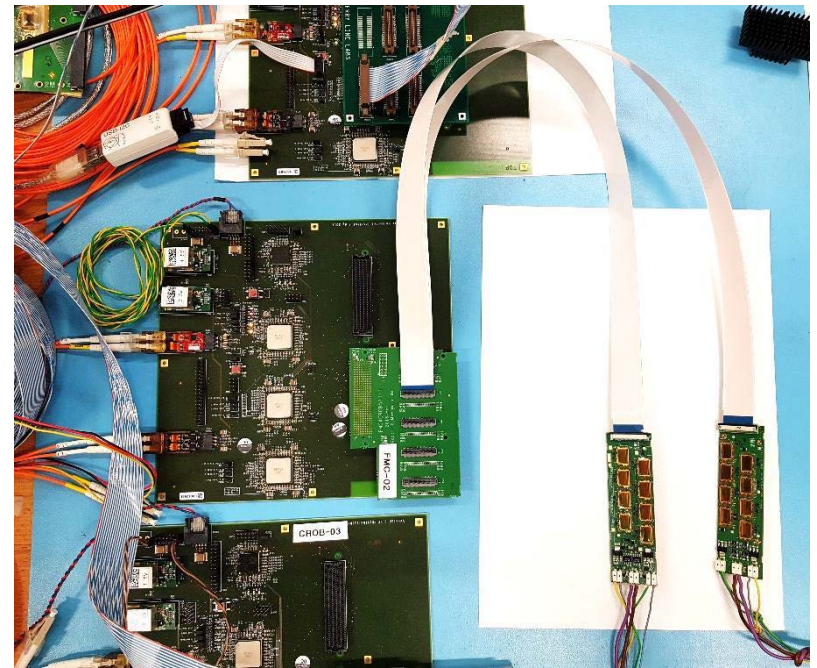
*current prototype
STS-XYTER v2.0*

*STS-XYTER v2.1
submitted*

*128 channels
self-triggering
5 bit ADC, time resolution < 5 ns*



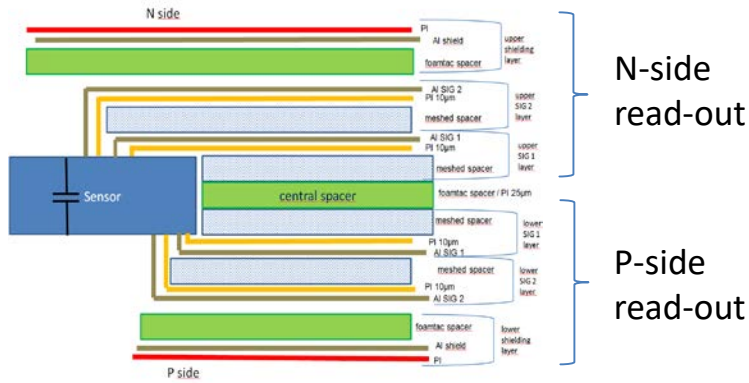
Front-end electronics board FEB-8



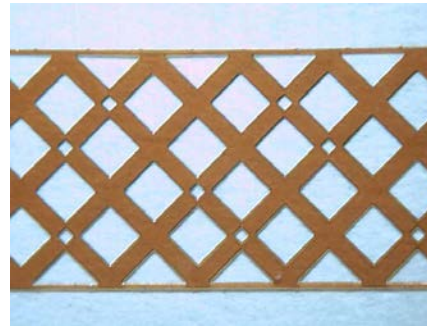
*Common Read-out Board test chain
with GBT chipset
(not applicable to BM@N)*

Micro-cables

cable stack: *thickness* $\sim 800 \mu\text{m} / 0.23\% X_0$

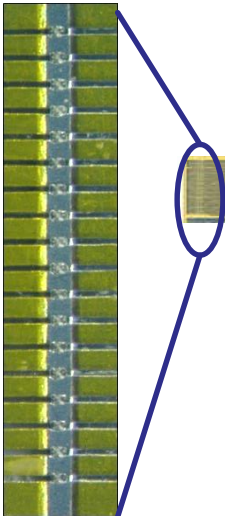
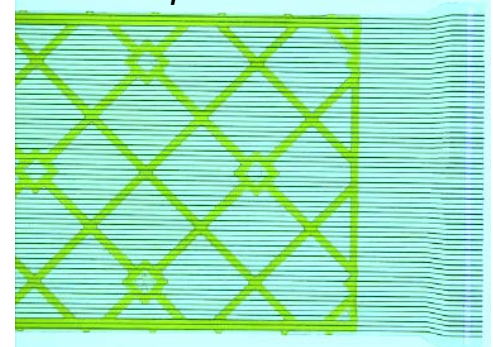


meshed spacer layer

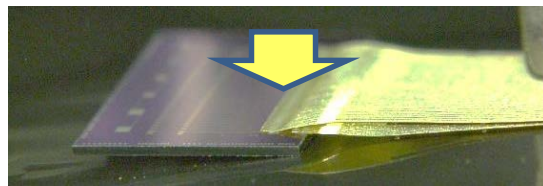


(foam spacers also)

*64 traces per signal layer
2 signal layers per cable
8 cables per sensor side*



signal layer: *64 Al lines of 116 μm pitch, 14 μm thick on 10 μm polyimide*



*tab-bonding of
2 signal layers to
Al pads on ASIC
and sensor*

trace capacitance 0.45 pF/cm
trace lengths 5 - 55 cm

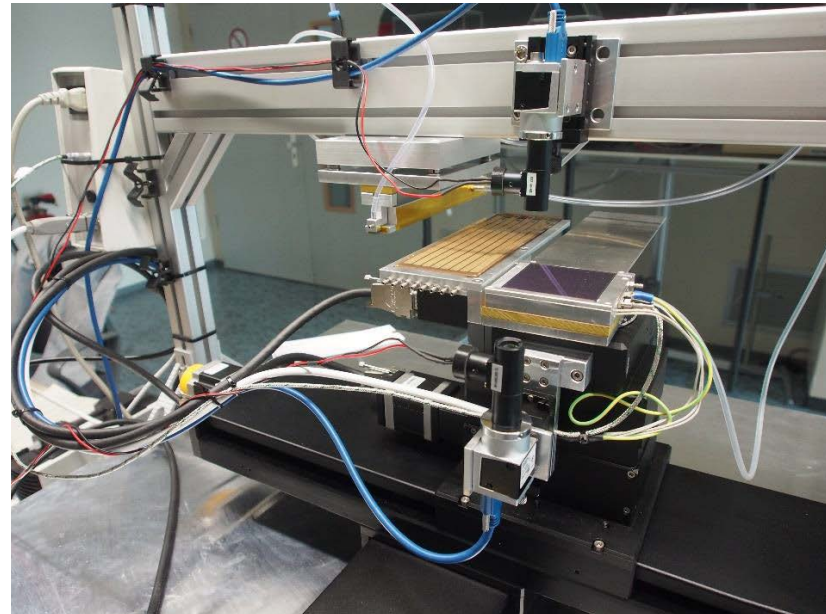
Alternative Cu cable under test.

STS assembly centers: GSI and JINR

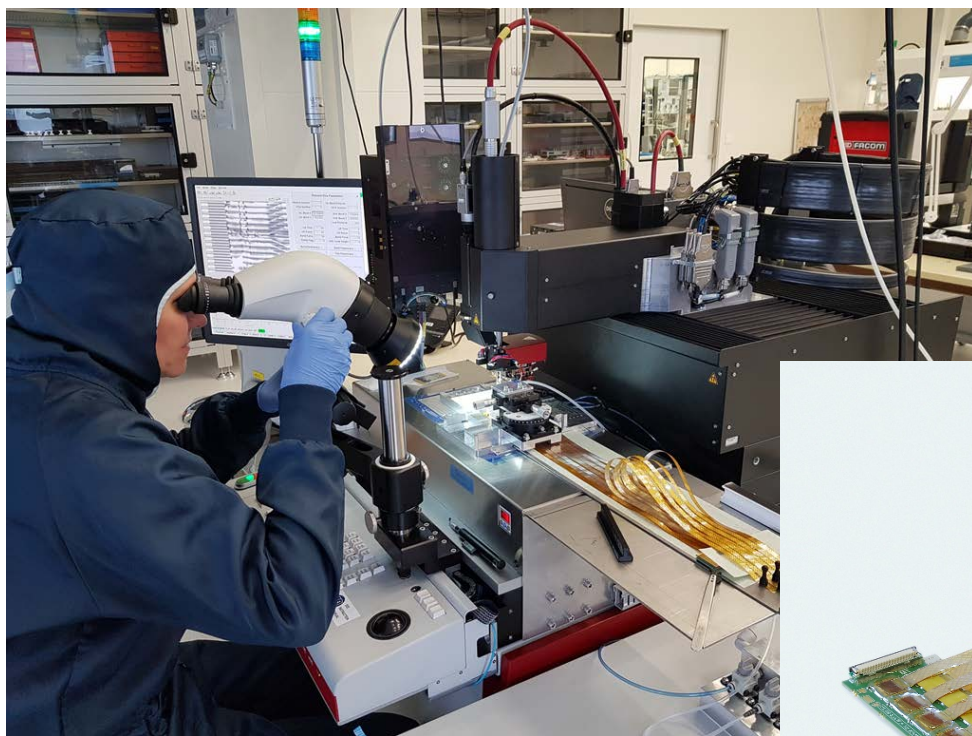


Module assembly satellite to GSI: KIT

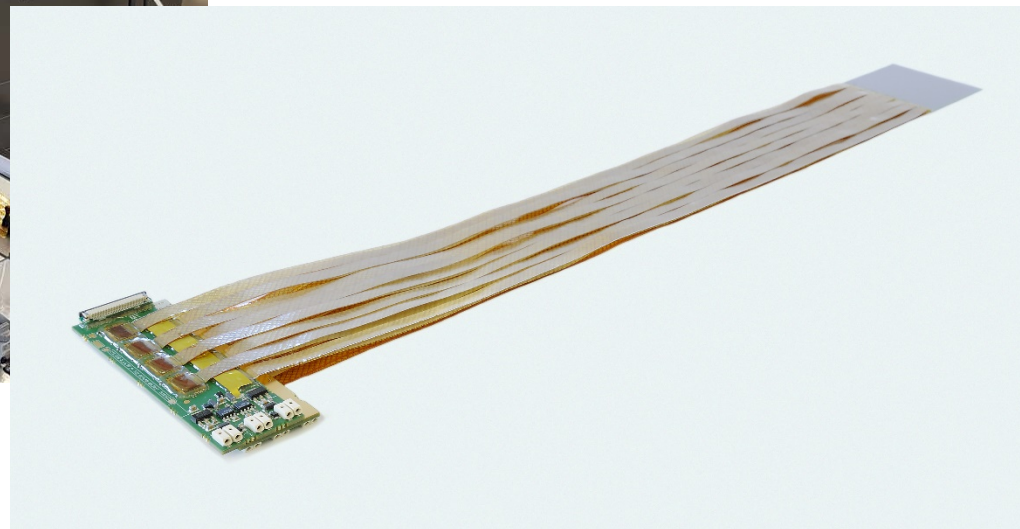
*Karlsruhe Institute of Technology,
Germany*



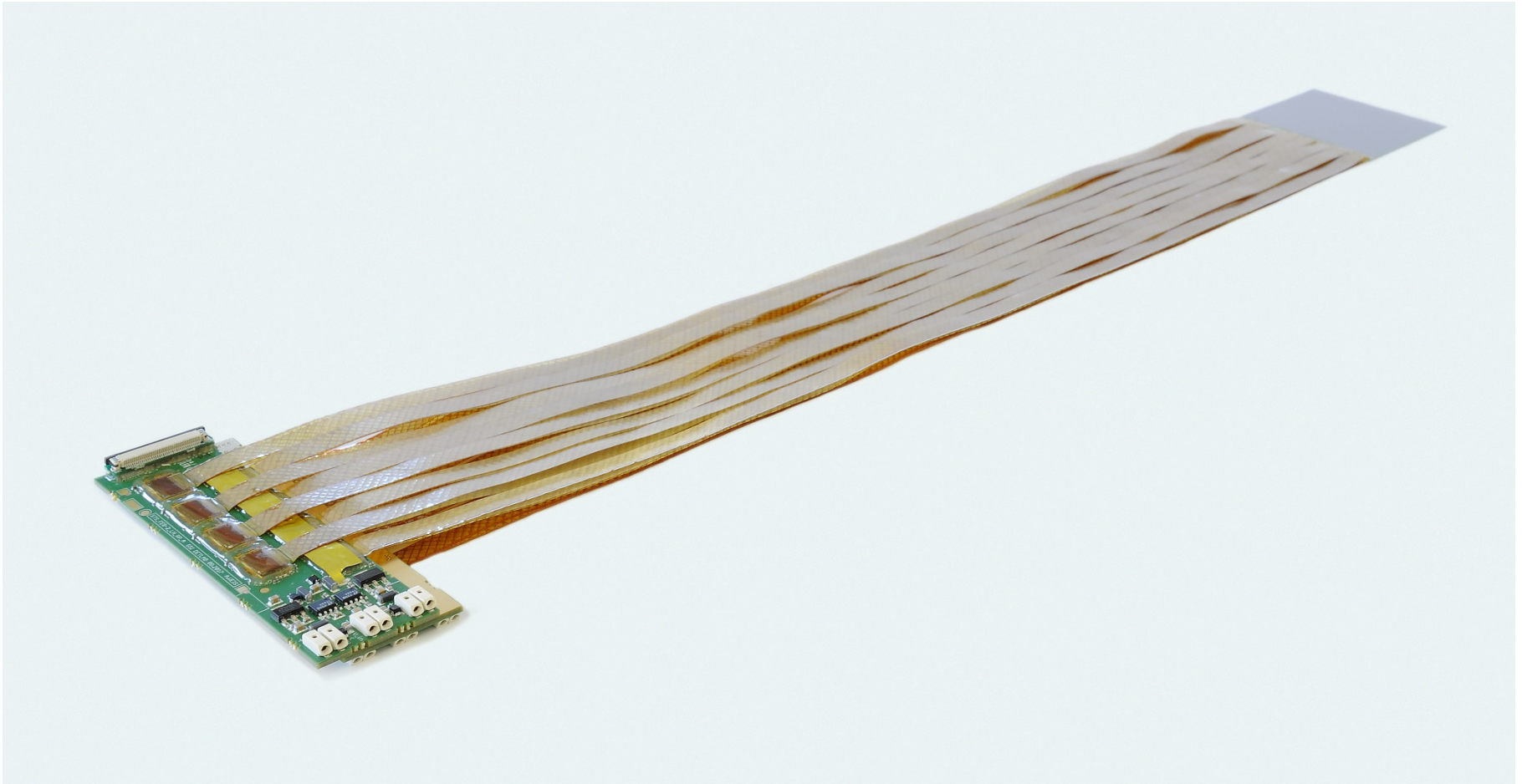
Module assembly at GSI



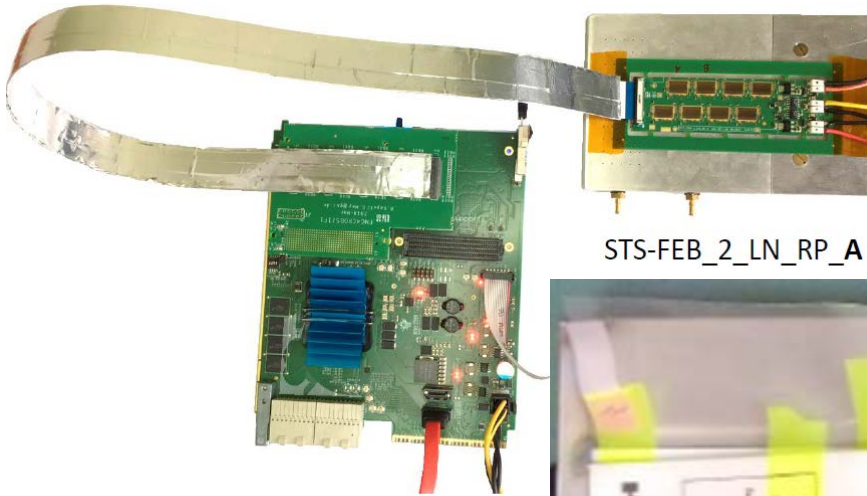
First full-size module for mSTS



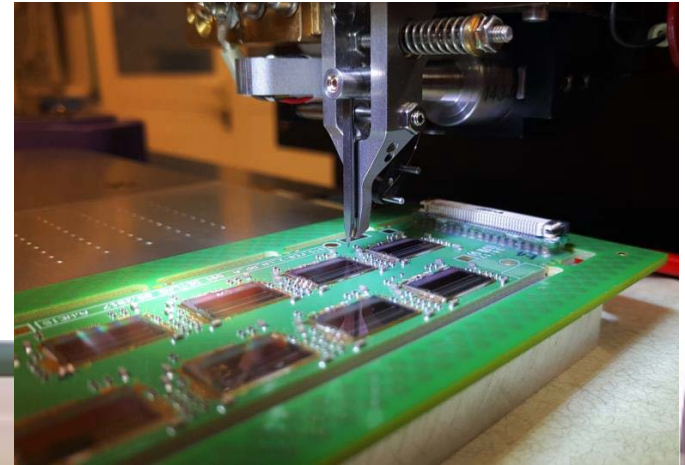
Module assembly at GSI



Module assembly at JINR-VBLHEP



STS-FEB_2_LN_RP_A



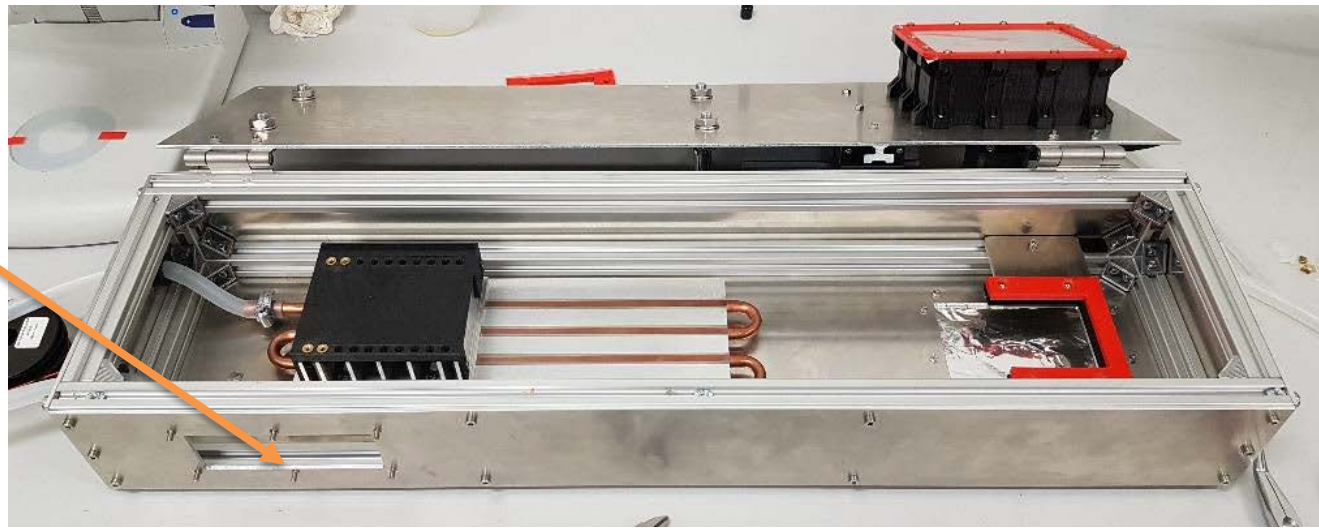
AFCK with STS-Feb2-FMC



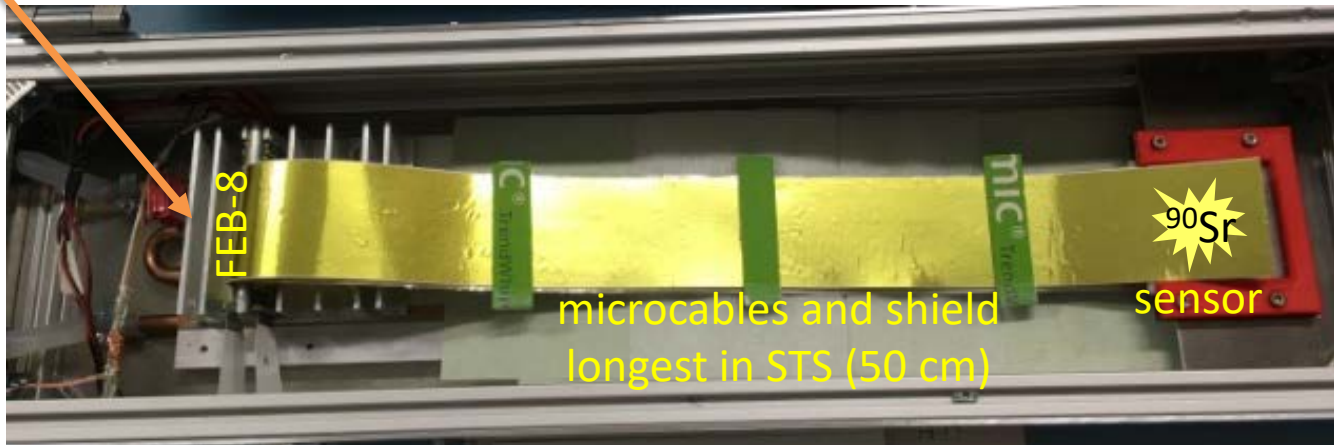
first fully
read-out
module

Module test stand at GSI

connections to
power supplies
and read-out
system, DAQ

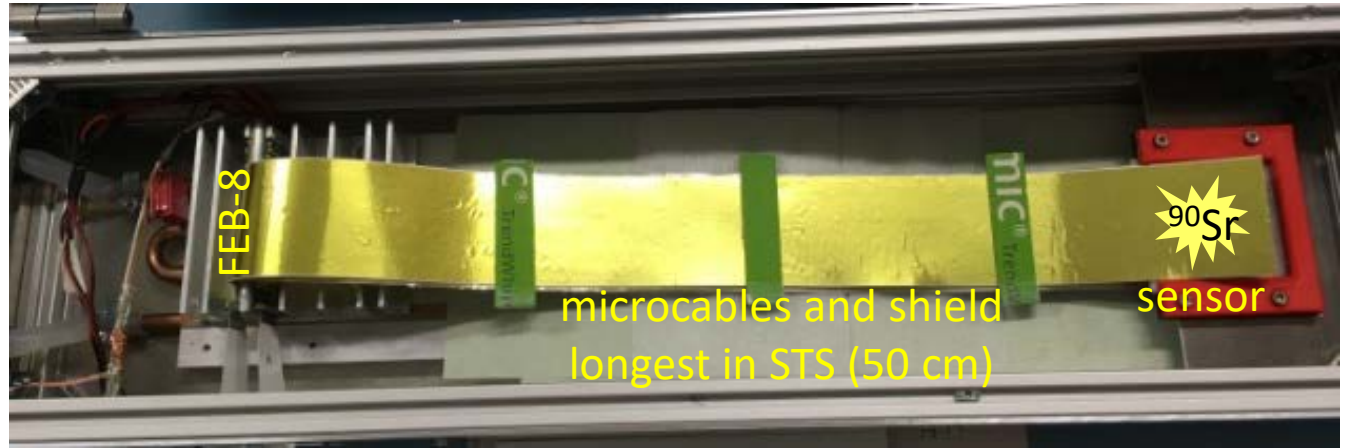


FEB-8 mounted
on cooling fins



First STS module with full 2-side r/o

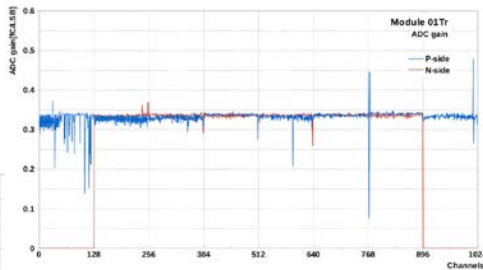
2 x 1024 channels
(front/back side)



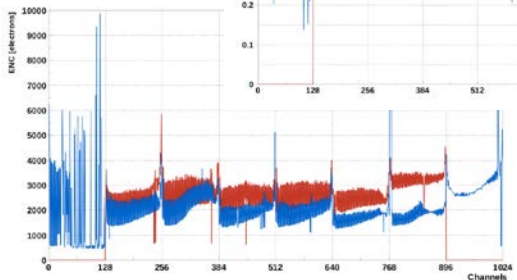
detailed study
ongoing

microcables and shield
longest in STS (50 cm)

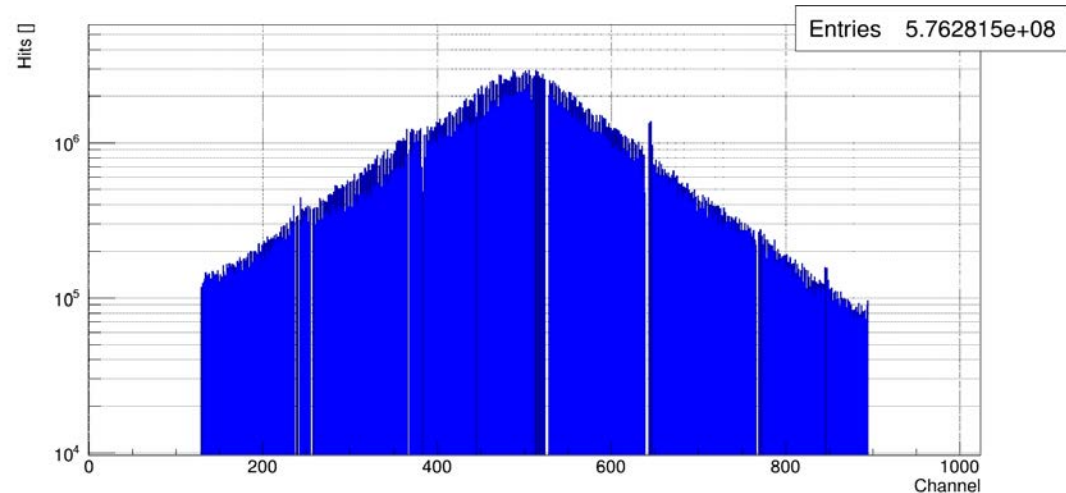
gain uniformity



noise

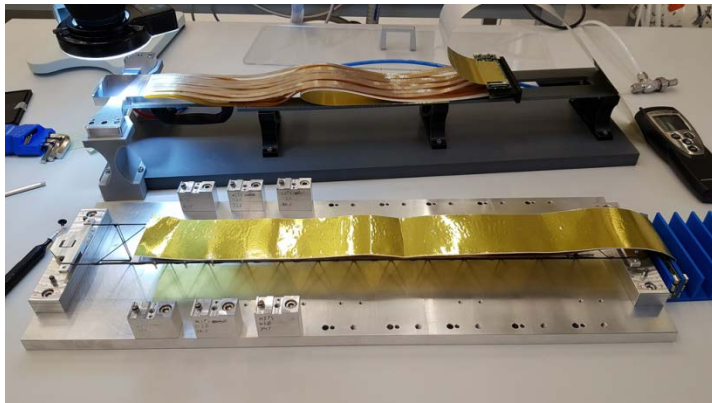
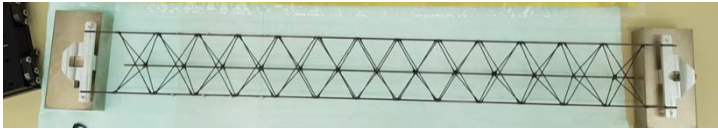


β -source spot

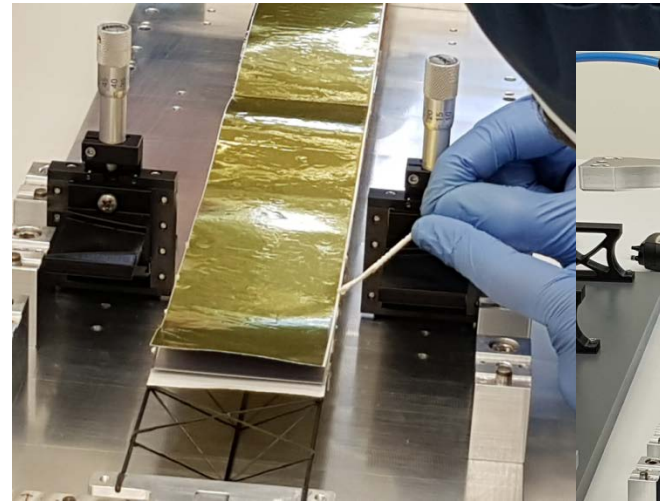


Ladder assembly at GSI

ladder #0 for mSTS

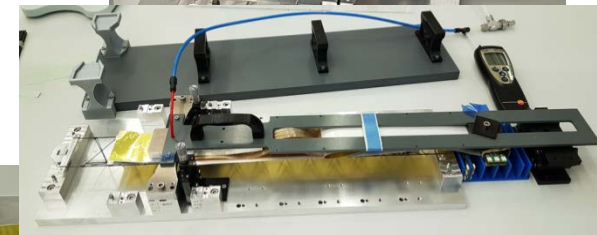
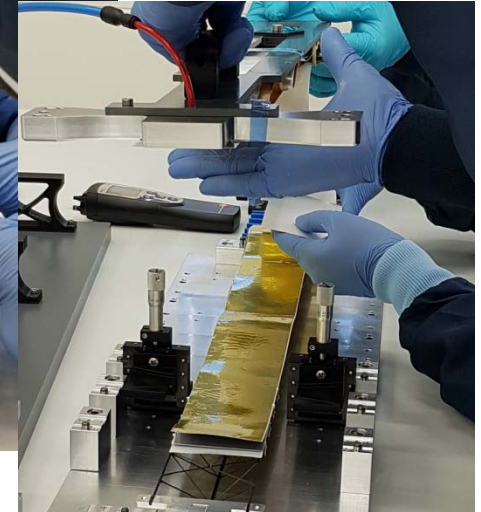


module #0 installed on ladder;
module #1 on transfer tool

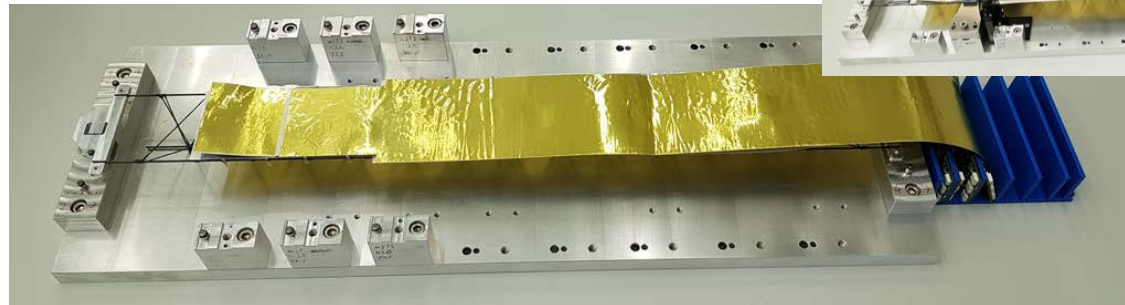


application of glue onto L-legs

transfer of module
#1 to ladder



module #1
transferred,
fixed during
curing of
glue

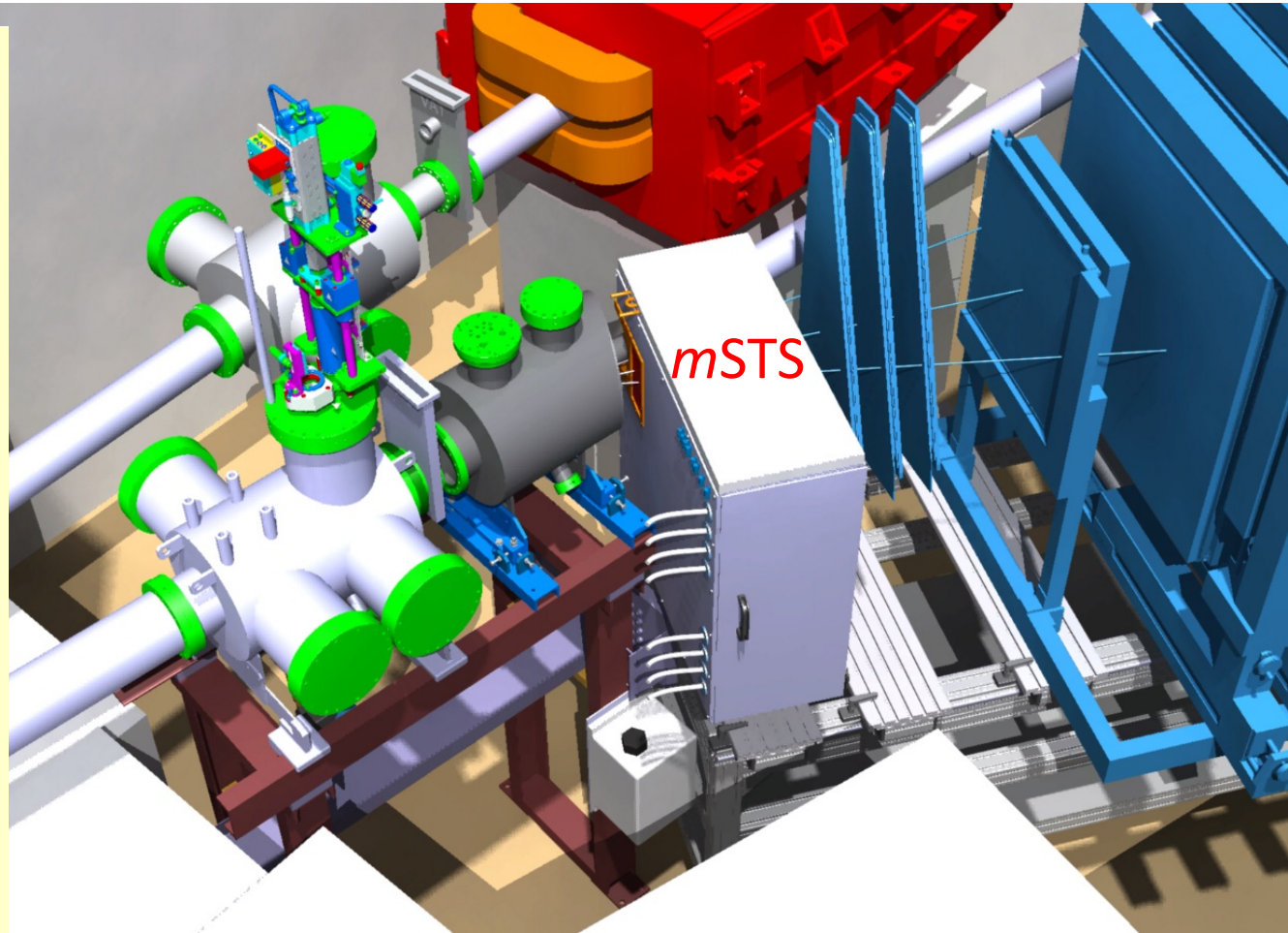


*m*STS in *m*CBM at SIS18

Demonstrator experiment for data transport and online event finding from prototype detector systems to the Green IT Cube

*m*STS
*m*MUCH
*m*TRD
*m*TOF
...

2018 –
2020/21/22

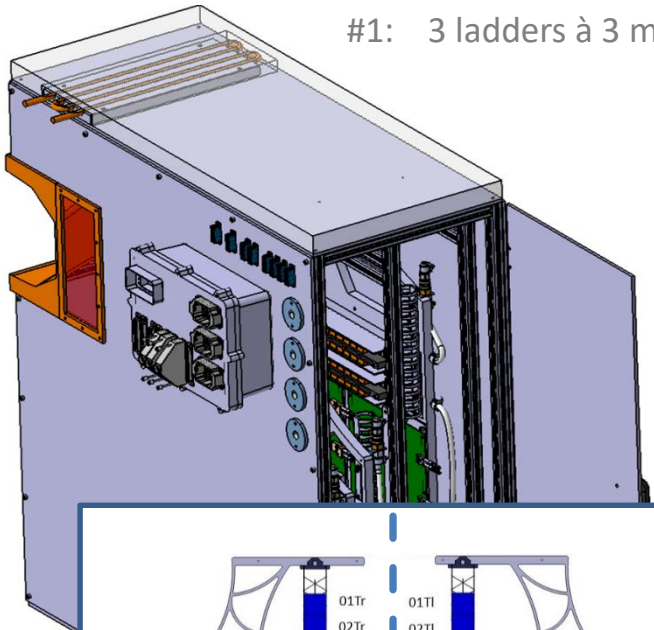


<https://fair-center.eu/for-users/experiments/nuclear-matter-physics/cbm/projects/mcbm.html>

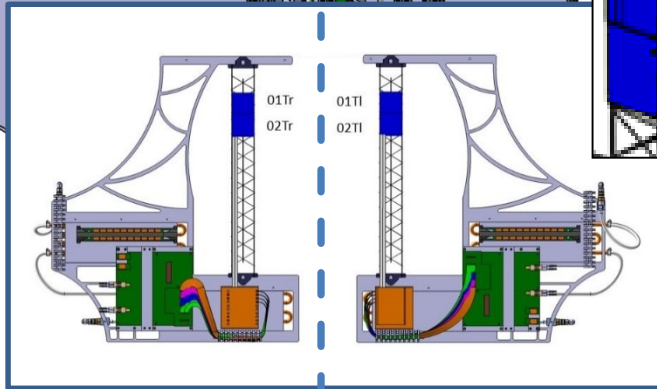
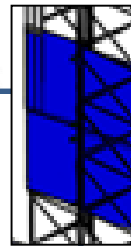
mSTS system

2 tracking stations:

- #0: 2 ladders à 2 modules (2018)
- #1: 3 ladders à 3 modules (add 2019)

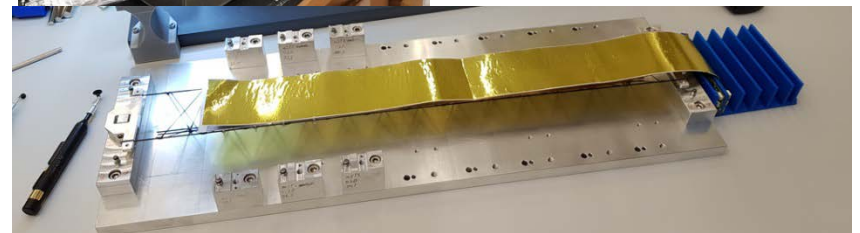
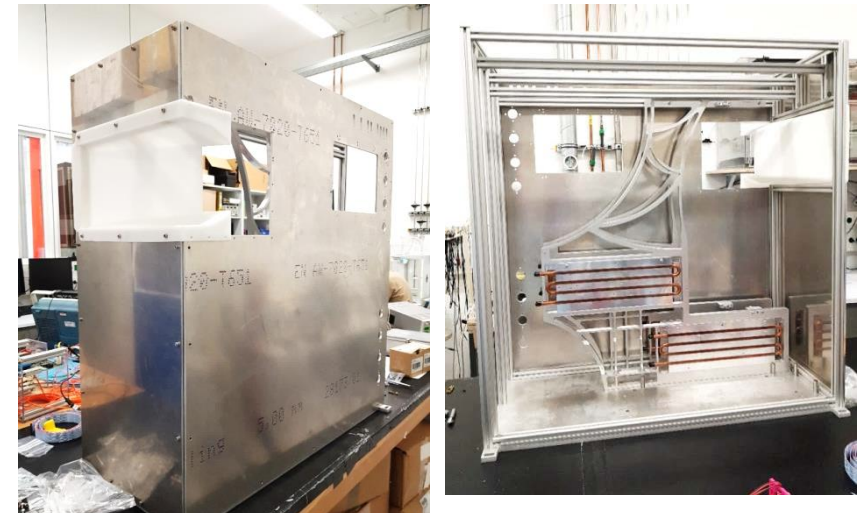


station #0
area 12 x 12 cm²



station #0: C-frames #0 and #1

mSTS box with C-frames



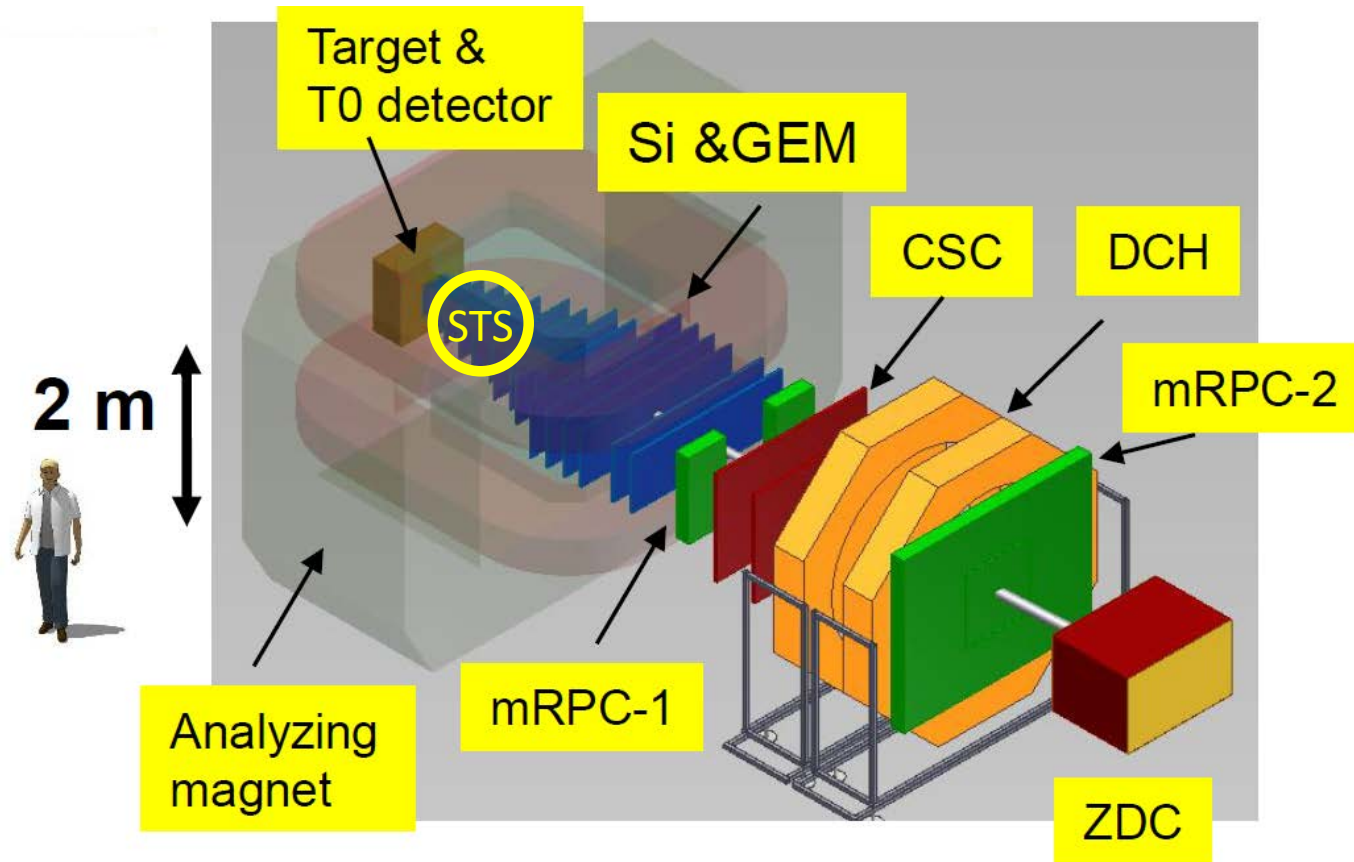
assembly of ladder #0

→ installation into mCBM: 11/2018

II.

System definition of BM@N-STS

STS in BM@N-2 experiment at Nuclotron



Workshop on DSSD-GEM Tracking System for BM@N-2

*5-6 July 2018
at JINR LHEP*

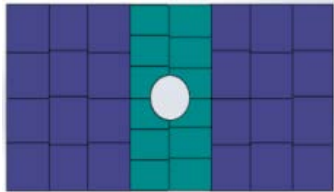


- BM@N upgrade for high intensity Au beams
- BM@N simulations
- BM@N-STS layout
- R/o electronics, DAQ
- CBM-STS status and project plan, link to BM@N-STS

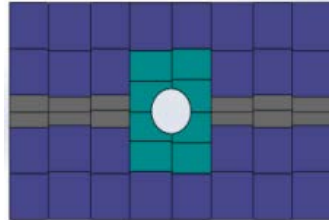
→ [Indico agenda](#)

JINR News 10 July 2018: <http://www.jinr.ru/posts/joint-plans-for-the-nearest-future/>

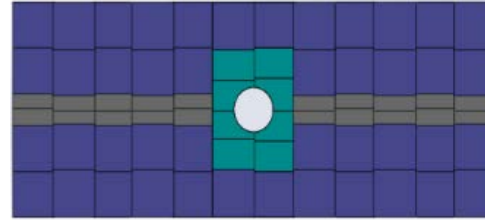
Tentative layout of the STS for BM@N2



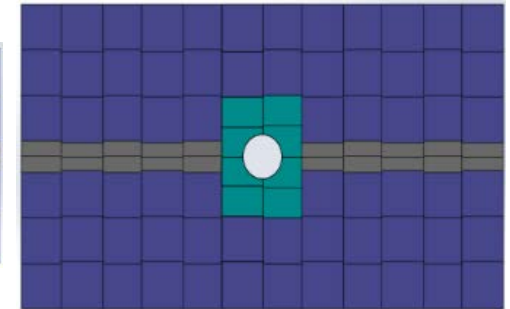
8 x 294 mm
pin to pin ladders



8 x 414 mm
pin to pin ladders



12 x 414 mm
pin to pin ladders

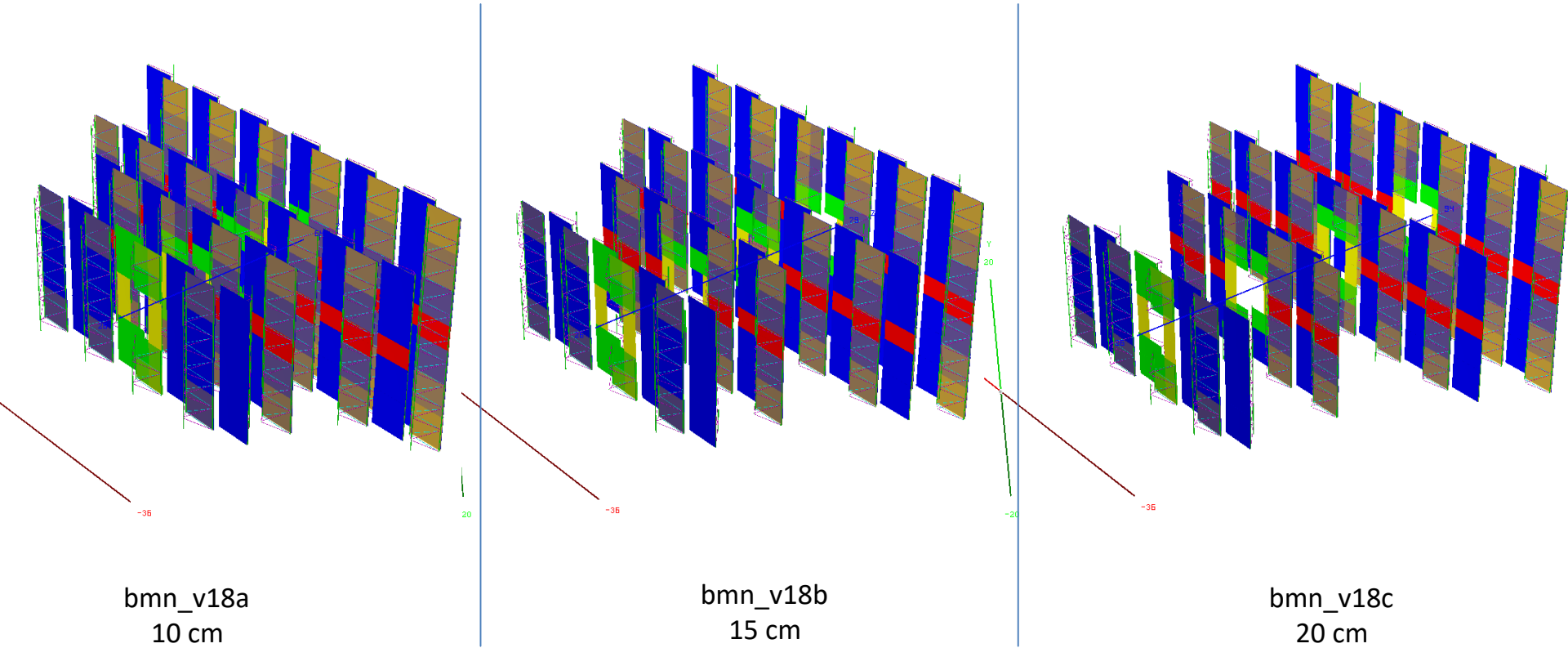


12 x 414 mm
pin to pin ladders

Num. of modules	Size of the sensor	Num. of modules	Size of the sensor	Num. of modules	Size of the sensor	Num. of modules	Size of the sensor
24	62*62 mm	44	62*62 mm	28	62*62 mm	68	62*62 mm
8	42*62 mm	4	42*62 mm	4	42*62 mm	4	42*62 mm
4	42*62c mm	4	42*62c mm	4	42*62c mm	4	42*62 mm
<i>36 modules</i>		20	22*62 mm	12	22*62 mm	20	22*62 mm
		<i>72 modules</i>		<i>48 modules</i>		<i>96 modules</i>	

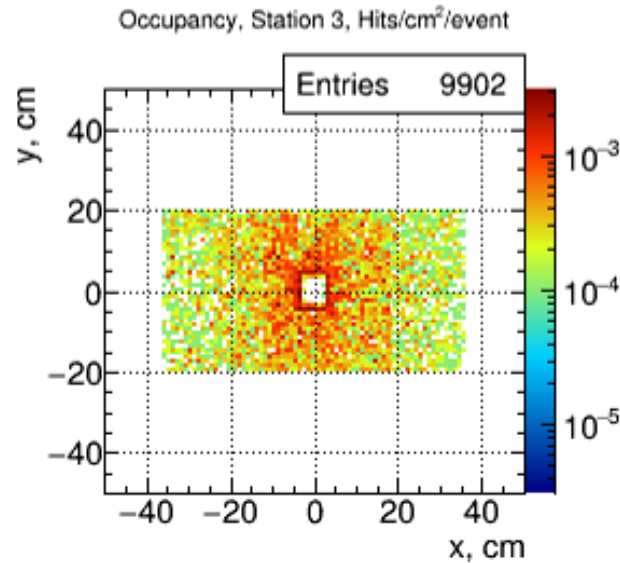
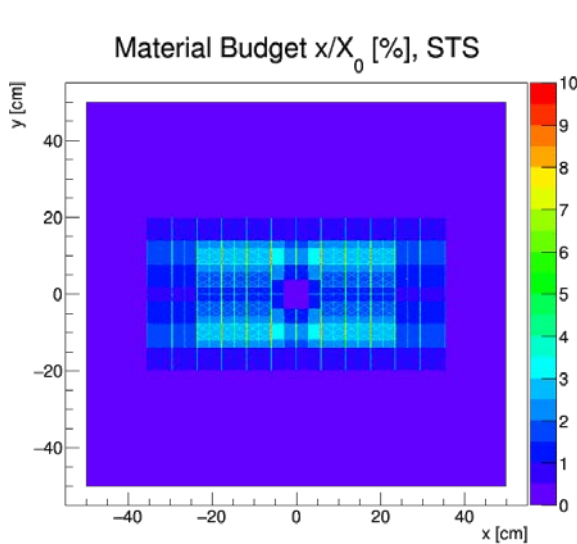
Total numbers: 252 modules, 40 ladders

Geometries



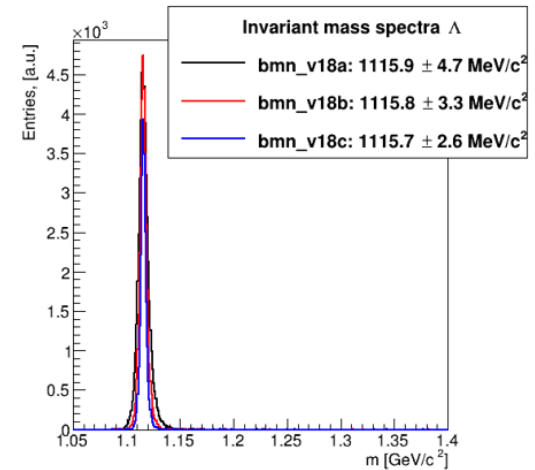
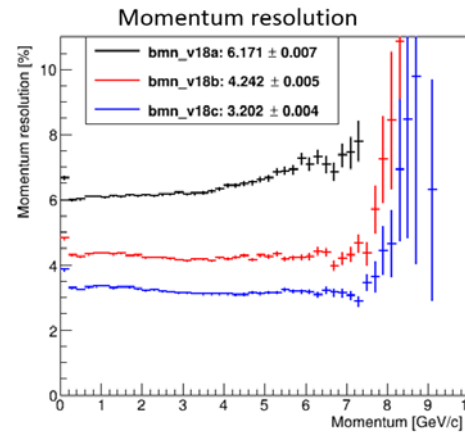
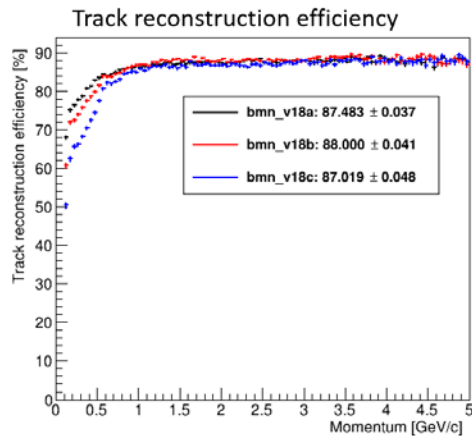
implemented for simulations (E. Lavrik, Univ. Tübingen)

Simulation studies



E. Lavrik, Univ. Tübingen:

- *geometry studies*
- *hit occupancies*
- *tracking efficiency*
- *momentum resolution*
- *physics observables*



III.

CBM-STS timeline, links to BM@N planning

CBM-ST S Project Plan
















Official planning document at GSI-FAIR, together with other planning documents from CBM, civil construction and accelerator.

General timeline: 2018 – 2024

- Pre-production phase: until Q3/2019 (mSTS completed with 2 tracking stations)
 - *development of final components and prototypes, as well as assembly methods*
- Production readiness: reviews/milestones - including:
 - *STS module/ladder assembly procedure:* 9/2018
 - *STS sensors ready for order* 10/2018
 - *STS Core Preliminary Design Review:* 11/2018

} *technology + procedure freeze*
- Production phase: 2019 until 2024 2/2024 *STS ready for installation*

CBM-STS Project Plan summary

Task Name	Start	Finish
STS ready for installation	22-02-24	22-02-24
 STS assembly and commissioning in lab	25-02-21	25-01-24
 Ladder assembly (GSI)	21-05-20	18-05-23
 Ladder assembly (JINR)	18-06-20	18-05-23
 Module assembly (GSI)	30-01-20	15-09-22
 Module assembly (KIT)	30-01-20	15-09-22
 Module assembly (JINR)	27-02-20	15-09-22
 STS-XYTER ASIC production	07-06-19	02-07-20
 Microcable production	06-04-19	12-04-21
 FEB-8 production	19-03-19	17-02-20
 Sensor production	10-01-19	07-12-20
 STS-XYTER ASIC production readiness review	06-06-19	06-06-19
 Sensor tendering completed, orders placed	27-02-18	10-12-18
 STS core readiness	30-10-18	30-10-18
 Module/ladder assembly readiness [internal]	15-09-18	15-09-18
 Sensor readiness	23-04-18	10-10-18

Upcoming CBM-STS milestones

- Sensor Readiness completed (10/2018)
 - Reviews held in 3/2017 and 4/2018
 - Summary report – Technical Note close to finalization
- Sensor tendering:
 - Deadline for reception of offers (28/9/ 2018)
 - Negotiations with vendors, orders placed (10 - 12/2018)
- Module/ladder assembly readiness [internal] (15/9/2018)
- STS core readiness (11/2018)
- mSTS with tracking station 0 installed in mCBM (11/2018)
- Start of sensor production (1/2019)
- Start of FEB-8 production (3/2019)
- Start of microcable production (4/2019)
- STS-XYTER ASIC production readiness review (6/2019)
- Start of STS-XYTER ASIC production (7/2019)
- mSTS with tracking stations 0 and 1 installed in mCBM (Q3/2019)

Links to BM@N-2 STS planning

- CBM-STS construction model fully detailed
 - modules and ladders exactly defined: **11/2018**
 - available for BM@N-STS construction model
- CBM-STS front-end electronics and read-out chain demonstrated
 - start adaptation for BM@N: in the course of mCBM preparation and running: **11/2018**
 - including prior definitions of BM@N r/o needs, e.g. at this meeting
- CBM-STS modules – first of series available
 - lessons learned from mSTS: **11/2018, Q3/2019**
 - start producing modules for BM@N-STS: **2/2020**
- CBM-STS ladders – first of series available
 - lessons learned from mSTS: **11/2018**
 - start producing ladders for BM@N-STS: **6/2020**

In order to use the same module and ladder make in BM@N as later in CBM:

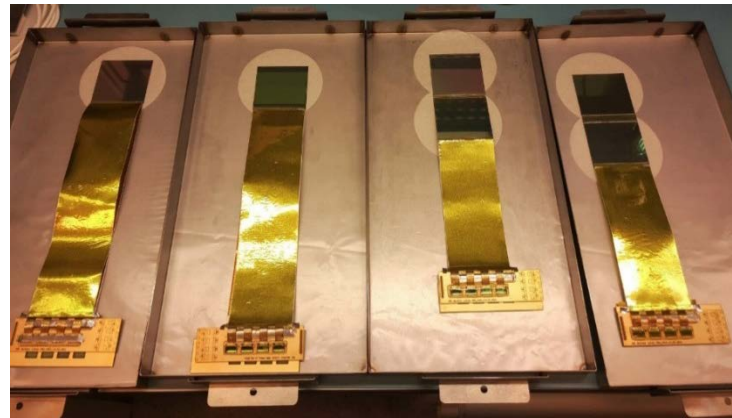
- modules available in larger numbers for BM@N earliest from mid 2020 on
- ladders available in larger numbers for BM@N-STS earliest from end 2020 on
- a few prototypes may be available already earlier (in 2019 - 2020)
- plan BM@N-STS system and component availability accordingly, detector completed in 2021?

Estimated module production time

module assembly – most time consuming assembly step

JINR team:

Basic stages of assembly	Number of elements (pcs)	Time for the operation (min)	Average assembly time (min)	People required for stage	Encapsulation (min)	Total running time (min)
Assembling of the p-side of the detector						
1 technician and 1 engineer						
Assembling the "Chip-Cable"	8	10	80	2	120	200
Cutting and testing	16	5	80	2		80
Sensor assembly	1	240	240	1	120	360
Total:			400			640
1 technician and 2 engineers						
Installation of chips on the PCB	4	5	20	1	80	100
Bonding of the 1 row of chips	1	15	15	1	30	45
Installation of chips on the PCB	4	5	20	1	80	100
Bonding of the 2 row of chips	1	15	15	1	30	45
Assembly shielding layer	1	30	30	2	120	150
Total:			100			440
Assembling of the n-side of the detector						
1 technician and 1 engineer						
Assembling the "Chip-Cable"	8	10	80	2	120	200
Cutting and testing	16	5	80	2		80
Sensor assembly	1	240	240	1	120	360
Total:			400			640
1 technician and 2 engineers						
Installation of chips on the PCB	4	5	20	1	80	100
Bonding of the 1 row of chips	1	15	15	1	30	45
Installation of chips on the PCB	4	5	20	1	80	100
Bonding of the 2 row of chips	1	15	15	1	30	45
Assembly shielding layer	1	30	30	2	120	150
Total:			100			440
Assembly time (h)	17		Assembly with encapsulation (h)	36		
Working time per day (h)	7		Working days per year	246		



Mockups modules assembled at JINR

Modules per month	10		
Modules per year	104		
Total	Time		
Time for assembly 252 modules	25	month	
Time to assembly 20% spare	5	month	

BM@N-STC modules:

2.5 years

Module + Ladder production volume

CBM-STS		
JINR assembly:	400 modules, 46 ladders	+ 15% spares
GSI (+KIT) assembly:	496 modules, 60 ladders	

BM@N-STS		
JINR assembly:	252 modules, 40 ladders	+ 15% spares

→ consider a further satellite lab
for at least the module assembly